



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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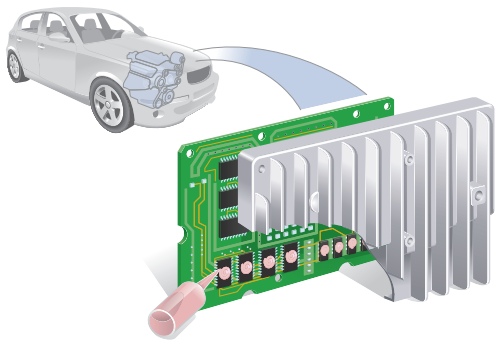
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# THERM-A-GAP™ GEL 8010 & GEL 30

## High Performance Fully Cured Dispensable GELS



### Description

Parker Chomerics fully cured dispensable GELS eliminate time-consuming hand assembly, decreasing installation costs and reducing customer manufacturing and purchasing (logistical) complexity. These products require no mixing or curing, providing superior design flexibility.

- Provides low thermal impedance at thin and thick gaps, allowing use of common heat spreaders
- Proven reliability in extreme temperature cycling and shock & vibration
- Deflects easily under very low compressive forces, decreasing stress on components thus decreasing component failures.

### Typical Applications

- Automotive Electronic Control Units (ECU's)
- Power Supplies & Semiconductors
- Memory & Power Modules
- Microprocessors / Graphics Processors
- Flat Panel Displays & Consumer Electronics

### Features/Benefits

- Easily dispensable
- Fully-cured / No pump out
- High bulk thermal conductivity
- Low thermal impedance
- Ultra low compression force
- High tack surface & reworkable
- Proven long-term reliability

Typical Properties		GEL 8010	GEL 30	Test Method
Physical	Color	White	Pink	Visual
	Flow Rate, grams/min - 30cc syringe with no tip attachment 0.100" orifice, 90psi (621 kPa)	60	20	Chomerics
	Specific Gravity	2.70	3.20	ASTM D792
	Percent Deflection @ Various Force Levels (See graph on following page)	% Deflection	% Deflection	Modified ASTM C165 Dispensed 1.0 cc of material Brought 1" x 1" probe down to 0.100" Test rate 0.025 in/min
	Typical minimum bondline thickness, in (mm)	0.002 (0.05)	0.004 (0.10)	Chomerics
Thermal	Thermal Conductivity, W/m-K	3.0	3.5	ASTM D5470
	Heat Capacity, J/g-K	1	1	ASTM E1269
	Coefficient of Thermal Expansion, ppm/K	150	150	ASTM E831
	Operating Temperature Range, °F (°C)	-67 to 392 (-55 to 200)	-67 to 392 (-55 to 200)	Chomerics
Electrical	Dielectric Strength, Vac / mil (KVac/mm)	200 (8.0)	200 (8.0)	ASTM D149
	Volume Resistivity, ohm-cm	10 <sup>14</sup>	10 <sup>14</sup>	ASTM D257
	Dielectric Constant @100 kHz	6.3	7.0	ASTM D150
	Dissipation Factor @ 100 kHz	0.002	0.002	Chomerics
Regulatory	Flammability Rating	V-0	V-0	UL 94
	RoHS Compliant	Yes	Yes	Chomerics Certification
	Outgassing, % TML (CVCM)	1.33 (0.34)	0.15 (0.05)	ASTM E595
	Shelf Life, months from date of manufacture	18	18	Chomerics

**Product Attributes**

**GEL 8010**

- Thin bondline gel (approximately 2-10 mils)
- Low thermal impedance gel
- Stencil printable with no pump out
- Ideal for high-volume dispensing
- Proven long-term reliability

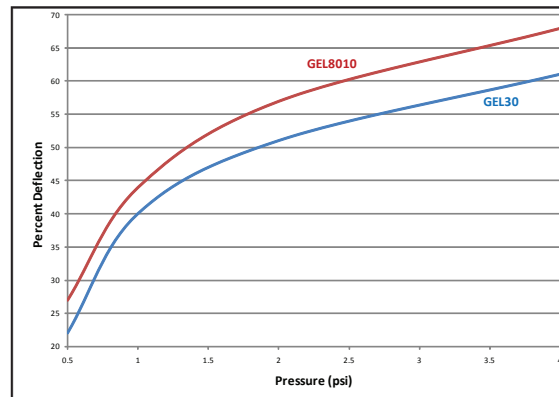
**GEL 30**

- Accommodates a variety of bond line thicknesses for application to multiple devices
- Gel 30 has been successfully used to fill a variety of different gap thickness. Please reference the Gel 30 Reliability test report for additional details and surface recommendations.
- High Bulk Thermal Conductivity
- Excellent performance-to-price
- Compatible with high volume, automated dispense processes
- Meets Telcordia (Bellcore) silicone specifications

**Installation Guidelines**

Thermal gels are supplied in plastic syringes and aluminum cartridges. Apply pressure to the rear of the cartridge, simply dispense the desired amount onto components or cooling plates. The gel is reworkable and excess material can be easily wiped off.

Since GEL 8010 gel is conformable, the gel can be stencil printed onto the plates. The thickness of the printed gel can be adjusted depending on the component type and size, but about 6mil thickness is recommended.



Percent Deflection vs. Pressure

**Ordering Information**

	<b>6W</b>	—	<b>XX</b>	—	<b>YYYYY</b>	—	<b>ZZZZ</b>
	<b>W</b>		<b>XX</b>		<b>YYYYY</b>		<b>ZZZZ</b>
<b>GELS</b>	5 = Standard Packaging		00		THERM-A-GAP GEL 8010 & GEL 30		0030 = 30cc Taper Tip Tube 0300 = 300cc Aluminum Cartridge (Caulking Style)
	9 = Custom Configuration		11		33579		GEL 8010 = 1 Gallon Pail (2800cc, 7.6Kg)*
				28020		GEL 30 = 1 Gallon Pail (2800cc, 9Kg)*	
				Custom Part Number		THERM-A-GAP GEL Material Code GEL 8010 & GEL 30	

\*High volume dispensing equipment required. Please contact Applications Engineering for additional support. Other custom container sizes may be available upon request

Dispensing Equipment Options	Optional Supplier	Description
Hand-Gun Pneumatic Dispensing 300cc cartridges	Bergdahl Associates	Semco Model 550
<a href="http://www.bergdahl.com">http://www.bergdahl.com</a>		
Pneumatic Shot Size Controllers 30cc, 180cc and 300cc Shot Size Dispensing Equipment	EFD	Ultra 2400 Series
		Ultra 1400 Series
		Ultra 870 Series
30cc/55cc Adapter Assembly	EFD	10000D5152
Dispensing Sleeve to support 6oz (180cc) Semco Tubes	EFD	5192-6
<a href="http://www.efd-inc.com">http://www.efd-inc.com</a>		

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